

EAST Search History

Ref #	Hits	Search Query	DBs	Default Operator	Plurals	Time Stamp
S1	1	((XUE-JAN) near2 (FAN)).INV.	US-PGPUB; USPAT; USOCR	AND	OFF	2007/12/03 10:56
S2	26	((PENG) near2 (XU)).INV.	US-PGPUB; USPAT; USOCR	AND	OFF	2007/12/03 10:57
S3	0	("2006/0180821").URPN.	USPAT	AND	OFF	2007/12/03 11:26
S4	19	"6226183"	USPAT	AND	OFF	2007/12/03 11:27
S5	31	"6477054" or "5792677" or "20030057534"	USPAT	AND	OFF	2007/12/03 11:43
S6	1	(S4 or S5) (flexible near (substrate or pcb or board))	USPAT	AND	ON	2007/12/03 11:43
S7	15	("5045921" "5161090" "5467251" "5708566" "5745984" "5792677"). PN. OR ("5896271"). URPN.	US-PGPUB; USPAT; USOCR	AND	OFF	2007/12/03 11:45
S10	4752	361/704,719,720.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/12/03 11:50
S11	6615	257/707,98,713,e23.105. ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/12/03 11:50
S12	5996	165/80.3,185.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/12/03 11:51
S13	2493	174/252,262.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/12/03 11:51

S14	603	(S10 or S11 or S12 or S13) trace via sink (pcb or board or substrate near (flexible))	US-PGRUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2007/12/03 11:52
S15	40	S14 (light adj2 diode)	US-PGRUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2007/12/03 11:53
S16	12	"60467857"	US-PGRUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2007/12/03 17:15
S17	36	("20020004251" "20020034834" "20020163006" "20020175621" "20020176250" "20030057421" "20040026706" "4886709" "5117281" "5122781" "5140220" "5482898" "5485037" "5581876" "5725808" "5745624" "5847935" "5857767" "5953203" "5977567" "6045240" "6220722" "6325524" "6376268" "6428189" "6455930" "6480389" "6483623" "6518502" "6634750" "6634770" "6692252").FN. OR ("7095053").URFN.	US-PGRUB; USPAT; USOCR	AND	OFF	2008/07/29 18:15
S18	5118	361/704,719,720.ccls.	US-PGRUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2008/07/30 08:55
S19	7132	257/707,98,713,e23.105.ccls.	US-PGRUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2008/07/30 08:55

S20	6315	165/80.3,185.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2008/07/30 08:55
S21	2656	174/252,262.ccls.	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2008/07/30 08:55
S22	644	(S18 or S19 or S20 or S21) trace via sink (pcb or board or substrate near (flexible))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 08:55
S23	830064	S22 (LED) or diode	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 08:55
S24	140	S22 (LED or diode)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 08:55
S25	119	S24 trace\$2 and layer\$2	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 08:56
S26	73	S25 (bonding or adhesive near (via or hole))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 08:57
S27	5	S26 (flexible near (substrate or board))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 08:58

S28	63	"6428189"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2008/07/30 09:09
S29	2640	(LED or diode) trace via sink (pcb or board or substrate near (flexible))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 09:47
S30	248	S29 (via near (thermal\$2))	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 09:48
S31	58	S30 not (S22 or S23 or S24 or S25 or S26 or S27)	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	ON	2008/07/30 09:49
S32	2	"20050225222"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2008/07/30 10:03
S34	36	"5386339"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2008/07/30 10:14
S35	72	"5604673"	US-PGPUB; USPAT; USOCR; EPO; JPO; DERWENT; IBM_TDB	AND	OFF	2008/07/30 10:15
S36	21	("5138436").PN. OR ("5604673").URPN.	US-PGPUB; USPAT; USOCR	AND	OFF	2008/07/30 10:26

7/30/2008 3:51:46 PM

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